

Description

The SFA0002 is the switching power supply IC for flyback circuit and has high accuracy error amplifier.

When the load of the power supply circuit becomes light, the operation of IC becomes the burst oscillation mode in order to improve the circuit efficiency.

By employing the primary side regulation, the IC realizes low component counts and design-friendliness, leading to downsizing and standardization of the power supply circuit.

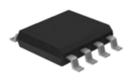
Features

- AEC-Q100 Qualified
- Current Mode Type PWM Control (Swithing frequency can be adjusted by external capacitor)
- Reducing External Component Count by Primary Side Regulation
- Built-in High Accuracy Error Amplifier ($V_{FB} = 2.5 \text{ V} \pm 2\%, -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$)
- Operation Mode Normal Operation: PWM Mode Light Load Operation: Burst Oscillation
- Soft Start Function (Startup time can be adjusted by external capacitor)
- Drive Output Stop Function

• Protections: Overcurrent Protection (OCP): Pulse-by-Pulse Overload Protection (OLP): Auto-restart Thermal Shutdown Protection (TSD) with hysteresis: Auto-restart

Package

SOP8



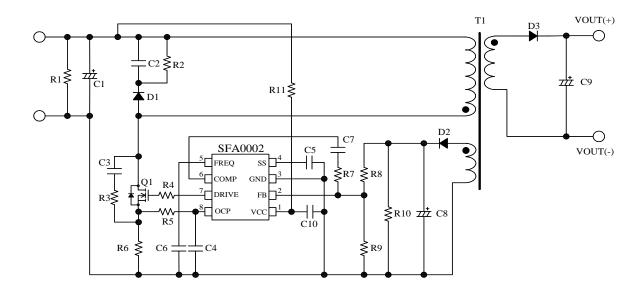
Not to scale

Specifications

- Power Supply Voltage is $V_{CC} = 36 V (max.)$
- Adjustable Swithing Frequency (20 kHz to 200 kHz)

Applications

- For following Isolation auxiliary power supply:
- Inverter
- On-board Charger (OBC)
- Battery Management System (BMS), etc.



Typical Application

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1. Absolute Maximum Ratings

Current polarities are defined as follows: current going into the IC (sinking) is positive current (+); and current coming out of the IC (sourcing) is negative current (-). Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit	Remarks
OCP Pin Voltage	V _{OCP}		-5 to 5	V	
SS Pin Voltage	V _{SS}		-0.3 to 9	V	
FB Pin Voltage	V_{FB}		-0.3 to 5	V	
VCC Pin Voltage	V _{CC}		0 to 36	V	
COMP Pin Voltage	V _{COMP}		-0.3 to 5	V	
FREQ Pin Voltage	V _{FREQ}		-0.3 to 5	V	
DRIVE Pin Peak Current	I _{DRV(PEAK)}		-270 to 540	mA	
DRIVE Pin DC Current	I _{DRV(DC)}		-90 to 180	mA	
Power Dissipation	P _D	* Mounting on PCB	1.2	W	
Junction Temperature	T _J		-40 to 150	°C	
Storage Temperature	T _{stg}		-40 to 150	°C	

* PCB: $42 \text{ mm} \times 32 \text{ mm}$ in size, 1 mm in thickness

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks
VCC Pin Voltage	V _{CC}		6		24	V	
Switching Frequency	f _{OSC}		20		200	kHz	

2. Recommended Operating Conditions

3. Electrical Characteristics

Current polarities are defined as follows: current going into the IC (sinking) is positive current (+); and current coming out of the IC (sourcing) is negative current (-).

Unless otherwise specified, $T_A = -40$ °C to 125 °C, VCC = 14 V, and FB = SS = OCP = 0 V.

The following electrical characteristics are design assurance value in $T_A = -40$ °C to 125 °C. The shipping test temperature of the products is -30 °C, 25 °C and 125 °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks
Power Supply Startup Opera	tion					1	
Operation Start Voltage	V _{CC(ON)}		4.9	5.1	5.3	V	
Operation Stop Voltage	V _{CC(OFF)}		4.4	4.6	4.8	V	
Circuit Current in Operation	I _{CC(ON)}		1.0	2.0	3.2	mA	
Circuit Current in Non-operation	I _{CC(OFF)}	VCC = 4.8 V	0.3	0.5	1.0	mA	
Normal Operation							
SS Pin High Threshold Voltage of OLP Operation	V _{HSS}		1.9	2.0	2.1	V	
SS Pin Low Threshold Voltage of OLP Operation	V _{LSS}		0.9	1.0	1.1	V	
SS Pin Voltage Hysteresis of OLP Operation	ΔV_{SS}	$V_{\rm HSS} - V_{\rm LSS}$	0.9	1.0	1.1	V	
SS Pin Source Current	I _{SRC(SS)}	SS = 0.9 V	-19	-15	-11	μA	
SS Pin Sink Current	I _{SNK(SS)}	SS = 2.1 V	13	17	21	μΑ	
Switching Frequency	f _{OSC(200 p)}	FREQ = 200 pF	85	100	115	kHz	
FREQ Pin Source Current	I _{SRC(FREQ)}	FREQ = 0.9 V	-33	-30	-27	μA	
FREQ Pin Sink Current	I _{SNK(FREQ)}	FREQ = 2.1 V	75	85	95	μA	
Oscillation Circuit High Threshold Voltage	V _{HF}		1.9	2.0	2.1	V	
Oscillation Circuit Low Threshold Voltage	V _{LF}		0.9	1.0	1.1	V	
Maximum Duty Cycle	D _{MAX}	FREQ = 200pF	70	74	78	%	
Slope Compensation Rate	SLP		2.1	2.5	2.9	mV/%	
Feedback Voltage	V _{FB}		2.45	2.50	2.55	V	
Burst Operation Threshold Voltage	V _{BURST}	FREQ = 200pF, COMP pin voltage increase from 0 V.		0.18	_	v	_
Drive Voltage	V _{DRIVE}	FREQ = 3 V, one pulse	7.6	8.3	9.0	V	

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Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks		
Minimum Drive Voltage	V _{DRIVE(MIN)}	$VCC \ge 6 V$, FREQ = 3 V, one pulse	4			v			
Minimum On Time	t _{ON(MIN)}	OCP = 1 V, DRIVE = 680 pF		170	_	ns			
Protection Function	Protection Function								
Leading Edge Blanking Time*	t _{BW}			100		ns			
OCP Threshold Voltage	V _{OCP}		0.46	0.5	0.54	V			
OLP Delay Time	t _{OLP}	SS = 10 nF	32	42	52	ms			
Drive Stop Threshold Voltage	V _{ST}		3.5	4.0	4.5	V			
Thermal Shutdown Operating Temperature*	T _{JH(TSD)}		150	165		°C			
Thermal Shutdown Release Temperature *	T _{JL(TSD)}			150	_	°C			

* Design assurance.

4. Performance Curves

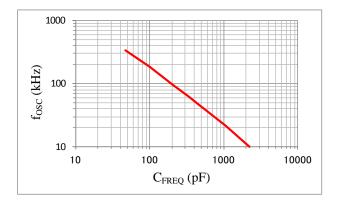


Figure 4-1. Switching Frequency, f_{OSC} , vs. FREQ Pin Capacitor, C_{FREQ}

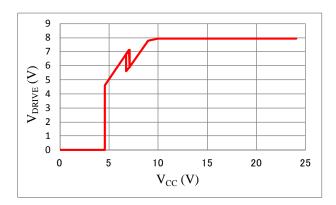


Figure 4-3. DRV Pin Voltage, V_{DRIVE} , vs. VCC Pin Voltage, V_{CC}

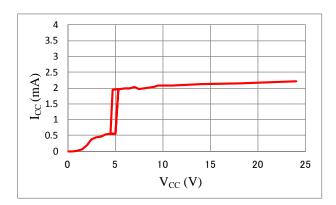


Figure 4-5. VCC Pin Current, I_{CC} , vs. VCC Pin Voltage , V_{CC}

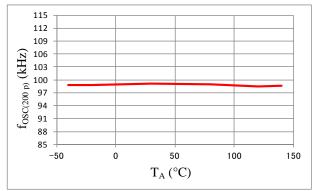


Figure 4-2. Switching Frequency (FREQ = 200 pF) Temperature Characteristics

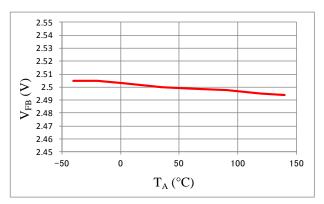
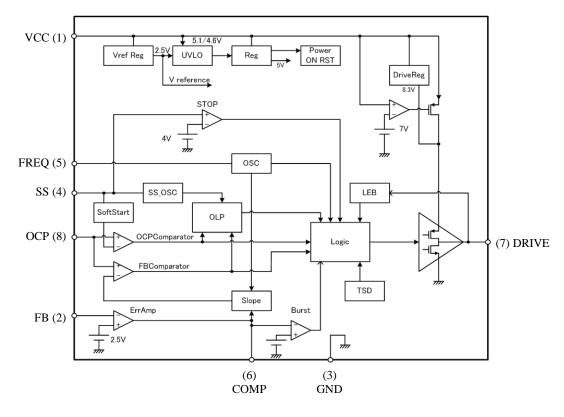
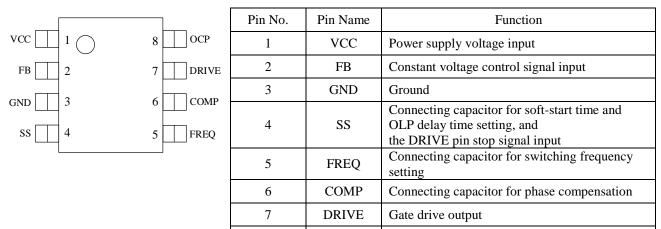


Figure 4-4. Feedback Voltage, V_{FB}, Temperature Characteristics

5. Block Diagram



6. Pin Configuration and Definitions



OCP

Overcurrent detection signal input

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7. Typical Application

In applications having a power supply specified such that the Drain pin of external power MOSFET has large transient surge voltages, a clamp snubber circuit of a capacitor-resistor-diode (C2, R2 and D1) combination should be added on the primary winding P, or a damper snubber circuit of a capacitor or a resistor-capacitor (C3 and R3) combination should be added between the Drain pin and the Source pin.

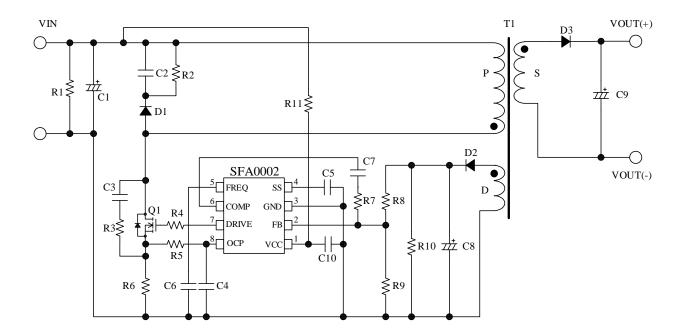
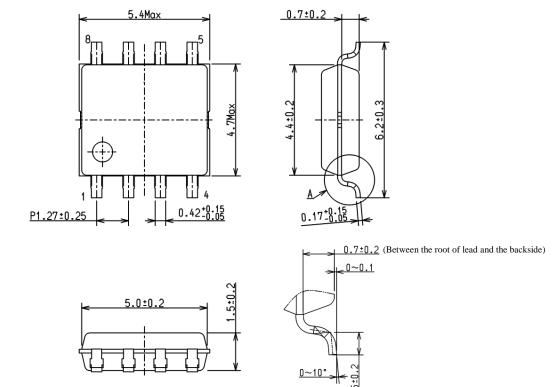


Figure 7-1. Typical Application Circuit

8. Physical Dimensions

• SOP8

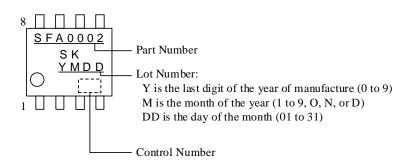


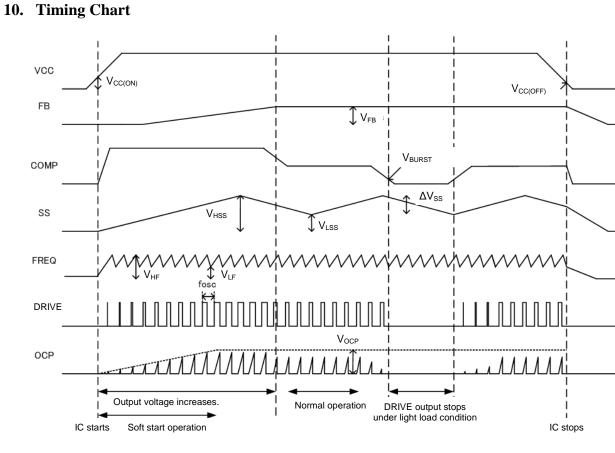
NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)

Enlarged View of A

9. Marking Diagram





When the COMP pin voltage decreases to V_{BURST} or less, the IC operation becomes into burst oscillation mode. The on-time and the intermittent cycle, etc. depend on the specification of typical application circuit.

Figure 10-1. Normal Operation

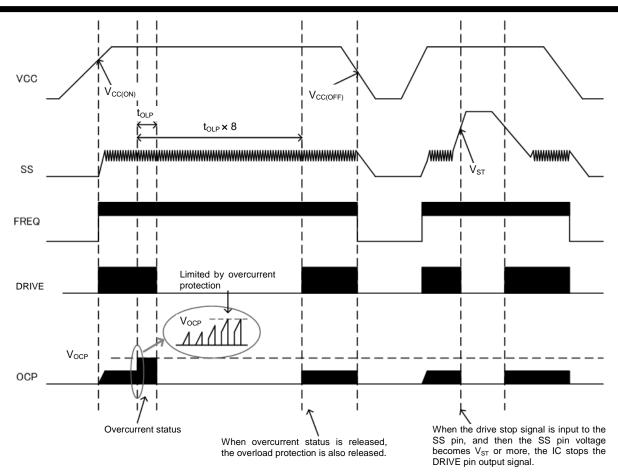


Figure 10-2. Protection Function

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